

## **PerfecTron**

# 3611300 3613UU

IEC-61850-3, IEEE-1613
SUBSTATION FANLESS COMPUTER



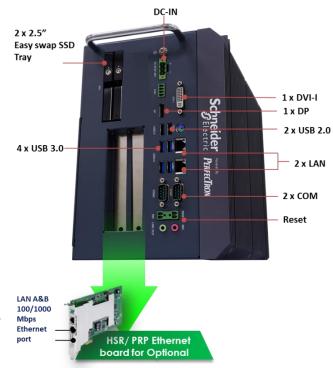
IEEE 1613....

- 9th Gen. Intel® Core™ i9/i7/i5 Processors
- SO-DIMM DDR4 2400/2666 MHz up to 64GB
- 2 x 2.5"Easy swap SSD Tray
- 2 x RJ45 LAN
- 4 x USB3.0, 2 x USB2.0
- 1 x DP, 1 x DVI, 4 PoE,
- 6 x COM (RS232/422/485)
- TPM Security on Board
- Extended Operating Temp. :-20°C~60°C

### Introduction

SCH300, a sophisticated fanless power substation solution with rich and powerful I/O connectors, such as 4 x PoE (RJ45 or M12), 6 x COM (RS232/422/485) with isolated DIDO (4 x DI, 4 x DO), and also 8 x USB ports. According to your actual requirement, there are flexible options like up to 10 x COM (RS232/422/485), or up to 10 x LAN (RJ45), and even at most 8 x POE (RJ45 or M12) for our energy customers.

Moreover, 9V-48V, an Ultra-Wide DC power input is really crucial for a stable and reliable power substation system. SCH300 allows the system to be utilized in extensive power types. And also, sudden drop or surge of power posts absolutely no threat to this smart and outstanding system.



One more thing, it's the optional HSR/ PRP Ethernet board. Which is an Ethernet Redundancy concept, and allows user to have a more stable and efficient solution for troubleshooting without any delay. As well as its extended operation temperature, -40~60°C, SCH300 is really a best solution of your smart power substation!

## **Key Features of SCH300**







- (1) SECURITY REDUNDANCY
- (2) NETWORK REDUNDANCY
- (3) RICH COMMUNICATION
- (4) IEC-61850-3

- INTERFACE
- (5) COMPREHENSIVE
- (6) IEEE-1613
- EXTENSION MODULE
- (7) EXTREME OPERATING
- (8) ULTRA WIDE VOLTAGE

**TEMPERATURE** 

SUPPORT

## **Key Feature**

#### (1)SECURITY REDUNDANCY

Integrating TPM module, operating systems can require an authentication to protect keys, data or systems.

## (3)RICH COMMUNICATION INTERFACE

In advantage of SCH300's diverse I/O, 6 x COM (All support RS232/422/485), 8 x USB, 4 x POE, 2 x LAN, the SCH300 system can meet all clients' communication requirement.

## (5)COMPREHENSIVE EXTENSION MODULE

No matter POE or LAN, M12 or RJ45 port, as well as full function RS232/422/485 COM port, SCH300 offers user with variety of options, which can meet all industrial/ energy critical needs.

## (7)EXTREME OPERATING TEMPERATURE

Ensure high reliability and stability while operating under a harsh environment such as temperature from -40°C up to 60°C

#### (2) NETWORK REDUNDANCY

PRP/HSR network is an efficient and cost effective solution to construct a seamless/bumpless communication infrastructure.

#### (4)IEC-61850-3

IEC 61850 defines the communication protocols for intelligent electronic devices at electric substations. IEC-61850-3 defines the complete testing requirement for the equipment which conforms to the standard.

#### (6)IEEE-1613

Detail environment and testing requirements for communications networking devices in electric power substations.

#### (8) ULTRA WIDE VOLTAGE SUPPORT

9V-48V, a very wide range voltage of DC-input capability, allows users to adopt all kinds of working site and applications scenario.

## **Specifications**

#### SYSTEM

CPU	9th Generation Intel® Core™ i9/i7/i5 Processors			
	Intel® Core™ i7-9700TE (12M Cache, up to 3.80 GHz)			
	Intel® Core™ i5-9500TE (9M Cache, up to 3.60 GHz)			
	Intel® Core™ i3-9100TE (6M Cache, up to 3.20 GHz)			
Memory type	2 x SO-DIMM up to 64GB DDR4-2666MHz			
REAR I/O				
Storage Device	2 x 2.5"Easy swap SSD Tray			
Expansion Slot	2 x PCle 3.0 X8			
Power Input	DC 9V~48V			
USB	4 x USB3.1, 2 x USB2.0			
Ethernet	2 x RJ45 LAN			
DisplayPort	1 x 20Pin DisplayPort connector (Female), resolution up to 4096x2160@60H:			
DVI	1 x 20Pin DVI-I connector, resolution up to 2560x1600@60Hz			
COM	6 x RS232 / 422 / 485 (Support Power 5V / 12V)			
FRONT I/O				
Power Button	1 x (with LED indicator)			
OS SUPPORT L	IST			
Windows	Win10 IoT Ent LTSB 2016, Win 10 IoT Ent 2019 LTSC			
Linux	Ubuntu18.04			
MECHANICAL &	ENVIRONMENT			
Dimension	170 x264 x 250 mm ( W x D x H )			
System Design	Fanless			
Mounting	Rackmount Cube			
Operating Temp.	-20°C to 60°C (35W CPU)			
Storage Temp	-40°C to 85°C			
Relative Humidity	5% to 95%, non-condensing			
CERTIFICATION				
EMC	CE, FCC compliant			



### MIL-STD-810G Test

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operating rests			
Low Tomporaturo	Method 502.5	exposure(24h x 3 cycle) at -40° ⊂ min.	
Low Temperature	Procedure 2	exposure(2411 x 3 cycle) at -40 ( 111111.	
High Tomporature	Method 501.5	60 <sup>o</sup> C for 2 hours after temperature	
High Temperature	Procedure 2	stabilization.	
Humidity.	Method 507.5	RH -95%. Test cycles: ten 24-hours ,	
Humidity	Procedure 2	functional test after 5th and 10th cycles	
Vibration	Method 514.6	10—500Hz 1.04Grms	
Vibration	Category 20	Test duration: 1 hours x 3 axis (total 3 hours)	
Charle	Method 516.6	200 11 - 5 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2	
Shock	Procedure 1	20G, 11mSec, 3 per axis	
Non-Operating Tests			
Low Temperature Storage	Method 502.5	exposure(24h x 7 cycle) at -40°C min.	
Lligh Tanan avatura Ctaraga	Method 501.5	71°C for 2 hours after temperature	
High Temperature Storage	Procedure 1	stabilization.	
	Method 514.6 Category 24	200 to 2000Hz	
Vibration		Test duration: One hour per axis; rms = 7.7	
		gs	
Clarada	Method 516.6	40C 11 2 ml	
Shock	Procedure V	40G, 11ms, 3 pluse.	





## **Ordering Information**

#### **SCH300**

Cube Fanless Computer for EcoStruxure Computer with 9th Generation Intel® Core™ i9/i7/i5 Processors,  $2 \times RJ45 \text{ LAN}$ , RAID 0/1 support, TPM onboard, HSR/PRP for optional,  $6 \times COM$  Ports,  $4 \times PoE$  (Up to 10 PoE for Optional), Wide range  $9 \sim 48 \text{V}$  DC-in, Operating Temperature -20°C to  $60^{\circ}\text{C}$ 

#### SCH3X1

Cube Fanless Computer for EcoStruxure Computer with 9th Generation Intel® Core™ i9/i7/i5 Processors, 2 x RJ45 LAN, RAID 0/1 support, TPM onboard, HSR/PRP for optional, 2 x COM Ports, Wide range 9~48V DC-in, Operating Temperature -20°C to 60°C

### **Mechanical Dimensions**

